

# 600mA Synchronous DC-DC Step Down Regulator (1ch) 300mA LDO Regulator (4ch) Multi Power Supply (High Efficiency Power LSI)

#### **FEATURES**

- High-Speed Response DC-DC Step Down Regulator Circuit that employs Hysteretic System
- DC-DC Step Down Regulator: 1-ch Input voltage Range VBAT: 2.5V to 5.5V DVDD: 1.7V to 3.0V Output voltage Range 0.8 V to 2.4 V Up to 600 mA Output Current
- I<sup>2</sup>C control (2-slave address selectable)
- 20 pin Wafer Level Chip Size Package (WLCSP) (Size: 1.56 mm × 2.06 mm, 0.4 mm Pitch)

#### **DESCRIPTION**

AN30183A is a multi power supply LSI which has High-Speed Response DC-DC Step Down Regulators (1-ch) and LDO Regulators (4-ch).

By this DC-DC system, when load current charges suddenly, it responds at high speed and minimizes the changes of output voltage.

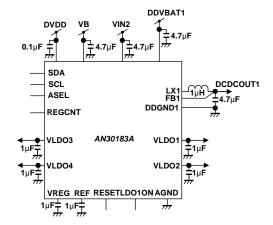
Since it is possible to use capacitors with small capacitance and it is unnecessary to add external parts for system phase compensation, this IC realizes downsizing of set and reducing in the number of external parts.

The output DC of each power supply is variable by  $I^2C$  control.

#### **APPLICATIONS**

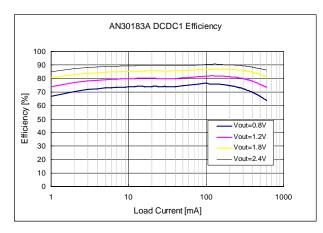
Mobile phone, Portable appliance, etc

#### SIMPLIFIED APPLICATION



Notes) This application circuit is an example. The operation of mass production set is not guaranteed. You should perform enough evaluation and verification on the design of mass production set. You are fully responsible for the incorporation of the above application circuit and information in the design of your equipment.

#### **EFFICIENCY CURVE**



Condition ) DDVBAT1 = DDVBAT2 = VB = VIN2 = 3.7V Lo =  $1.0 \mu$ H, Cout =  $4.7 \mu$ F



#### **ABSOLUTE MAXIMUM RATINGS**

| Parameter                      | Symbol                                  | Rating                           | Unit | Notes    |
|--------------------------------|---|----------------------------------|------|----------|
| Supply voltage                 | VB,VIN2,DDVBAT1                         | 6.0                              | V    | *1       |
| Supply voltage                 | DVDD                                    | 3.6                              | V    | *1       |
| Output Current                 | I <sub>IN</sub>                         | _                                | Α    | *1       |
| Operating free-air temperature | T <sub>opr</sub>                        | - 30 to + 85                     | °C   | *2       |
| Operating junction temperature | T <sub>j</sub>                          | - 30 to + 150                    | °C   | *2       |
| Storage temperature            | $T_{stg}$                               | - 55 to + 150                    | °C   | *2       |
| Input Voltage Penge            | RESET,LDO1ON,FB1,<br>REGCNT             | – 0.3 to V <sub>VBAT</sub> + 0.3 | V    | *1<br>*3 |
| Input Voltage Range            | SCL,SDA,ASEL                            | - 0.3 to DVDD + 0.3              | V    | *1<br>*3 |
| Output Voltage Range           | LX1,VREG,REF,SDA<br>LDO1,LDO2,LDO3,LDO4 | ' ' '   = 0.3 to V = 0.3         |      | *1<br>*3 |
| ESD                            | HBM (Human Body Model)                  | 2                                | kV   | _        |

Notes) Do not apply external currents and voltages to any pin not specifically mentioned.

This product may sustain permanent damage if subjected to conditions higher than the above stated absolute maximum rating. This rating is the maximum rating and device operating at this range is not guaranteeable as it is higher than our stated recommended operating range. When subjected under the absolute maximum rating for a long time, the reliability of the product may be affected.

# **POWER DISSIPATION RATING**

| PACKAGE   | $\theta_{JA}$ | PD ( Ta = 25 °C) | PD ( Ta = 85 °C ) | Notes |
|---|---------------|------------------|-------------------|-------|
| 20 pin Wafer level chip size Package (WLCSP Type) | 359.0 °C / W  | 0.348 W          | 0.181 W           | *1    |

Note). For the actual usage, please refer to the PD-Ta characteristics diagram in the package specification, follow the power supply voltage, load and ambient temperature conditions to ensure that there is enough margin and the thermal design does not exceed the allowable value.

<sup>\*1:</sup>Glass Epoxy Substrate ( 4 Layers ) [ Glass-Epoxy: 50 X 50 X 0.8 t ( mm ) ] Die Pad Exposed , Soldered.



#### **CAUTION**

Although this has limited built-in ESD protection circuit, but permanent damage may occur on it. Therefore, proper ESD precautions are recommended to avoid electrostatic damage to the MOS gates

<sup>\*1:</sup>The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

<sup>\*2:</sup>Except for the power dissipation, operating ambient temperature, and storage temperature, all ratings are for Ta = 25 °C.

<sup>\*3:</sup> $V_{VBAT}$  is voltage for DDVBAT1 = VB = VIN2, ( $V_{VBA}$  + 0.3) V must not be exceeded 6 V.

 $V_{DVDD}$  is voltage for DVDD,  $(V_{DVDD} + 0.3)$  V must not be exceeded 3.6 V.



#### RECOMMENDED OPERATING CONDITIONS

| Parameter            | Pin Name | Min.  | Тур. | Max.                    | Unit | Notes |
|----------------------|----------|-------|------|-------------------------|------|-------|
|                      | VB       | 2.5   | 3.7  | 5.5                     | V    | *1    |
| Cumply voltage range | VIN2     | 2.5   | 3.7  | 5.5                     | V    | *1    |
| Supply voltage range | DDVBAT1  | 2.5   | 3.7  | 5.5                     | V    | *1    |
|                      | DVDD     | 1.7   | 1.85 | 3.0                     | V    | *1    |
|                      | RESET    | - 0.3 | _    | V <sub>VBAT</sub> + 0.3 | V    | *2    |
|                      | LDO10N   | - 0.3 | ı    | V <sub>VBAT</sub> + 0.3 | V    | *2    |
|                      | REGCNT   | - 0.3 | 1    | V <sub>VBAT</sub> + 0.3 | V    | *2    |
| Input Voltage Range  | FB1      | - 0.3 | 1    | V <sub>VBAT</sub> + 0.3 | V    | *2    |
|                      | SCL      | - 0.3 | ı    | DVDD + 0.3              | V    | *2    |
|                      | SDA      | -0.3  |      | DVDD + 0.3              | V    | *2    |
|                      | ASEL     | - 0.3 | 1    | DVDD + 0.3              | ٧    | *2    |
|                      | LX1      | - 0.3 |      | V <sub>VBAT</sub> + 0.3 | V    | *2    |
|                      | VREG     | - 0.3 |      | V <sub>VBAT</sub> + 0.3 | V    | *2    |
|                      | REF      | - 0.3 | _    | V <sub>VBAT</sub> + 0.3 | V    | *2    |
| Output Voltage Bong  | SDA      | - 0.3 | ı    | DVDD + 0.3              | V    | *2    |
| Output Voltage Rang  | VLDO1    | - 0.3 |      | V <sub>VBAT</sub> + 0.3 | V    | *2    |
|                      | VLDO2    | - 0.3 | _    | V <sub>VBAT</sub> + 0.3 | V    | *2    |
|                      | VLDO3    | - 0.3 |      | V <sub>VBAT</sub> + 0.3 | V    | *2    |
|                      | VLDO4    | - 0.3 | _    | V <sub>VBAT</sub> + 0.3 | V    | *2    |

Note) Do not apply external currents and voltages to any pin not specifically mentioned.

Voltage values, unless otherwise specified, are with respect to GND. GND is voltage for AGND = DDGND1  $V_{VBAT}$  is voltage for DDVBAT1 = VB = VIN2.

<sup>\*1 :</sup> The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

 $<sup>^{\</sup>star}2$  : (V<sub>VBAT</sub> + 0.3) V must not be exceeded 6 V. (DVDD + 0.3) V must not be exceeded 3.6 V.



# **ELECRTRICAL CHARACTERISTICS**

 $V_{VBAT}(DDVBAT1=VB=VIN2)=3.7V,~DVDD=1.85V~DC-DC$  : Co = 4.7  $\mu F,~Lo$  = 1  $\mu H$  / LDO : Co =1.0  $\mu F$ 

 $T_a$  = 25  $^{\circ}C$   $\pm$  2  $^{\circ}C$  unless otherwise noted.

|    | Parameter                       |        | Symbol Conditions                  |   | Limits |     |      | Notes |
|----|---------------------------------|--------|------------------------------------|---|--------|-----|------|-------|
|    |                                 |        |                                    |   | Тур    | Max | Unit | Notes |
| Co | nsumption current               |        |                                    | • | •      |     |      | ·     |
|    | Consumption current 1 on active | IBAT_1 | only LDO1 (PS mode) ON             | _ | 10     | 20  | μΑ   | _     |
|    | Consumption current 2 on active | IBAT_2 | DCDC1, LDO1-4 = ON                 | _ | 240    | 400 | μΑ   | _     |
|    | Static consumption current      | IBAT_3 | DCDC1, LDO1-4 = OFF<br>RESET = "L" | _ | 0.1    | 1.0 | μА   |       |



# **ELECRTRICAL CHARACTERISTICS** (Continued)

 $V_{VBAT}(DDVBAT1=VB=VIN2)=3.7V,\ DVDD=1.85V$  DC-DC : Co = 4.7  $\mu$ F, Lo = 1  $\mu$ H / LDO : Co =1.0  $\mu$ F

 $T_a$  = 25  $^{\circ}C$   $\pm$  2  $^{\circ}C$  unless otherwise noted.

|     | Parameter                        | Symbol        | Conditions  |            | Limits |       | Unit | Notes |
|-----|----------------------------------|---------------|---|------------|--------|-------|------|-------|
|     | Parameter                        | Cymbol        |   | Min        | Тур    | Max   | Unit | Notes |
| LDO | O1 – 4 ( Normal Mode ) - (LDO R  | egulator)     |   |            |        |       |      |       |
|     | Output voltage                   | VLDO          | ILDO = - 150 mA<br>Vout = 1.85 V setting  | 1.803      | 1.850  | 1.897 | V    | _     |
|     | Output current                   | ILDO          | _   | 300        | _      | _     | mA   | _     |
|     | Load regulation                  | DVLDO         | $\Delta$ ILDO = $-10 \mu A \rightarrow -150 mA$   | <b>-</b> 5 | 20     | 50    | mV   |       |
|     | Line regulation                  | VLDOLR        | $VB = 3.1 \text{ V} \rightarrow 4.5 \text{ V}$ $ILDO = -150 \text{ mA}$ $Vout = 1.85 \text{ V setting}$ | - 10       | 0      | 10    | mV   |       |
|     | Short-circuit current            | ISTLDO        | VB = 3.7 V<br>VLDO = 0 V  | 35         | 100    | 255   | mA   | _     |
| LDO | D1 – 4 ( Power Save Mode ) - (LI | DO Regulator) |   |            |        |       |      |       |
|     | Output voltage                   | VLDOPS        | ILDO = - 5 mA<br>Vout = 1.85 V setting  | 1.803      | 1.850  | 1.897 | V    | _     |
|     | Output current                   | ILDOPS        | _   | 10         | _      | _     | mA   | -     |
|     | Load regulation                  | DVLDOPS       | $\Delta$ ILDO = $-$ 10 $\mu$ A $\rightarrow$ $-$ 5 mA   | -5         | 20     | 50    | mV   | _     |
|     | Line regulation                  | VLDOLRPS      | $VB = 3.1 \text{ V} \rightarrow 4.5 \text{ V}$ $ILDO = -5 \text{ mA}$ $Vout = 1.85 \text{ V setting}$   | - 25       | 0      | 25    | mV   | _     |



# **ELECRTRICAL CHARACTERISTICS** (Continued)

 $V_{VBAT}(DDVBAT1=VB=VIN2)=3.7V,~DVDD=1.85V$  DC-DC : Co = 4.7  $\mu F,~Lo=1~\mu H$  / LDO : Co =1.0  $\mu F$ 

 $T_a$  = 25  $^{\circ}C$   $\pm$  2  $^{\circ}C$  unless otherwise noted.

|     | Devenuetes                                   | Coursels al   | Conditions  |                       | Limits |                       | المنا | Notes |
|-----|--|---------------|---|-----------------------|--------|-----------------------|-------|-------|
|     | Parameter                                    | Symbol        | Conditions  | Min                   | Тур    | Max                   | Unit  | Notes |
| DC  | DC1 (DC-DC Step Down Regula                  | tor)          |   |                       |        |                       |       |       |
|     | Output voltage                               | VDCDC1        | IDCDC1 = - 300 mA<br>Vout = 1.2 V setting   | 1.170                 | 1.200  | 1.230                 | V     | _     |
|     | Output current                               | IDCDC1        | _   | 600                   |        | _                     | mA    | _     |
|     | Load regulation                              | DVDCDC1       | $\Delta$ IDCDC1 = $-10 \mu A \rightarrow -500 mA$<br>Vout = 1.2 V setting   |                       | 25     | 45                    | mV    | _     |
|     | Line regulation                              | VDCDC1LR      | DDVBAT1 = $3.1 \text{ V} \rightarrow 4.5 \text{ V}$<br>IDCDC1 = $-300 \text{ mA}$<br>Vout = $1.2 \text{ V}$ setting | l                     | 4      | 13                    | mV    |       |
|     | Oscillation frequency                        | ISTDCDC1      | IDCDC1 = - 300 mA (CCM)   | 2                     | 3      | 4                     | MHz   | _     |
| I/O | characteristics of control termina           | I (RESET, LDC | D1ON, REGCNT)   |                       |        |                       | •     |       |
|     | Low input voltage                            | VIL1          | Voltage recognized as low level   | _                     | _      | 0.45                  | V     | _     |
|     | High input voltage                           | VIH1          | Voltage recognized as high level  | 1.2                   | _      | _                     | V     | _     |
|     | Input pull-down resistance                   | PDR1          | _   | 1                     | 3      | 6                     | МΩ    | _     |
| I/O | I/O characteristics of control terminal (ASE |               |   |                       |        |                       |       |       |
|     | Low input voltage                            | VIL2          | Voltage recognized as low level   | _                     |        | $V_{DVDD} \times 0.3$ | V     | _     |
|     | High input voltage                           | VIH2          | Voltage recognized as high level  | $V_{DVDD} \times 0.7$ | _      | _                     | V     | _     |



#### APPLICATION INFORMATION

REFERENCE VALUES FOR DESIGN  $V_{VBAT}(DDVBAT1 = VB = VIN2) = 3.7V, DVDD = 1.85V$ 

 $T_a$  = 25 °C ± 2 °C unless otherwise noted.

|                  | Parameter                              | Cumbal | Conditions  | Refe                  | rence va | alues   | Unit | Notes    |
|------------------|--|--------|---|-----------------------|----------|---|------|----------|
|                  | i arameter                             |        | Symbol Conditions   |                       | Тур      | Max   | Unit | Notes    |
| I <sup>2</sup> C | Bus (Internal I/O Stage Characteristic | cs)    |   |                       |          |   |      |          |
|                  | Low-level input voltage                | VIL1   | Voltage which recognized that SDA and SCL are Low-level         | - 0.5                 | l        | $\begin{array}{c} 0.3 \times \\ V_{DVDD} \end{array}$ | V    | *1<br>*2 |
|                  | High-level input voltage               | VIH1   | Voltage which recognized that SDA and SCL are High-level        | $0.7 \times V_{DVDD}$ | _        | V <sub>DVDD</sub><br>max<br>+ 0.5                     | V    | *1<br>*2 |
|                  | Low-level output voltage 1             | VOL1   | V <sub>DVDD</sub> > 2 V<br>SDA(sink current) = 3 mA             | 0                     | _        | 0.4   | V    | *2       |
|                  | Low-level output voltage 2             | VOL2   | V <sub>DVDD</sub> < 2 V<br>SDA(sink current) = 3 mA             | 0                     |          | $0.2 \times V_{DVDD}$                                 | V    | *2       |
|                  | Input current each I/O pin             | IL     | SCL, SDA = $0.1 \times V_{DVDDmax}$ to $0.9 \times V_{DVDDmax}$ | <b>–</b> 10           | _        | 10  | μА   | *2       |
|                  | SCL clock frequency                    | FOSC   | _   | 0                     | _        | 400   | kHz  | *2       |

Notes) \*1 : The input threshold voltage of I $^2$ C bus (Vth) is linked to V $_{\text{DVDD.}}$ 

In case the pull-up voltage is not  $V_{DVDD}$ , the threshold voltage (Vth) is fixed to (( $V_{DVDD}$  / 2)  $\pm$  (Schmitt width) / 2 ) and High-level, Low-level of input voltage are not specified.

In this case, pay attention to Low-level (max.) value ( $V_{\rm ILmax}$ ).

It is recommended that the pull-up voltage of I2C bus is set to the I2C bus I/O stage supply voltage (V<sub>DVDD</sub>).

<sup>\*2 :</sup>Checked by design, not production tested.



REFERENCE VALUES FOR DESIGN

 $V_{VBAT}(DDVBAT1 = VB = VIN2) = 3.1V \ to \ 4.5V, \ V_{DVDD} = 1.85V \ , \ DC-DC : Co = 4.7 \ \mu F, \ Lo = 1 \ \mu H \ / \ LDO : Co = 1.0 \ \mu F \ T_a = 25 \ ^{\circ}C \pm 2 \ ^{\circ}C \ unless \ otherwise \ noted.$ 

|    | Doromotor                        | Cumbal       | Conditions   | Refe  | rence va | lues  | Unit | Notes |
|----|----------------------------------|--------------|--|-------|----------|-------|------|-------|
|    | Parameter                        | Symbol       | Conditions   | Min   | Тур      | Max   | Unit | Notes |
| LD | D1 – 4 ( Normal Mode ) - (LDO Re | egulator)    |  |       |          |       |      |       |
|    | Output voltage                   | VLDO         | ILDO = - 150 mA<br>Vout = 1.85 V setting   | 1.803 | 1.850    | 1.897 | V    | *2    |
|    | Consumption current on active    | IREGLDO      | Normal mode<br>VB > Vout + 0.1 V or<br>VIN2 > Vout + 0.1 V   | 25    | 50       | 75    | μΑ   | *2    |
|    | I/O voltage difference           | VSATLDO      | ILDO = - 300 mA  | 0.3   | _        | _     | V    | *2    |
|    | Ripple rejection                 | VLDORR       | $\Delta\text{VB} = 3.7\text{V} \pm 0.15\text{V}$ $\text{ILDO} = -150\text{mA}$ $\text{fvin} = 100\text{Hz} \text{ to } 10\text{kHz}$ |       | - 60     | - 40  | dB   | *2    |
|    | Discharge resistance             | RDISLDO      | _  | 50    | 100      | 200   | kΩ   | *2    |
|    | Load change characteristic       | LTRLDO       | ILDO = $-10 \mu A \leftrightarrow -100 \text{ mA}$   | _     | 30       | 150   | mV   | *2    |
| LD | O1 – 4 ( Power Save Mode ) - (LD | O Regulator) |  |       |          |       |      |       |
|    | Output voltage                   | VLDOPS       | ILDO = - 5 mA<br>Vout = 1.85 V setting   | 1.803 | 1.850    | 1.897 | V    | *2    |
|    | Consumption current on active    | IREGLDOPS    | Power Save mode<br>VB > Vout + 0.1 V or<br>VIN2 > Vout + 0.1 V   | 1     | 3        | 5     | μΑ   | *2    |
|    | Ripple rejection                 | VLDOPSRR     | $\Delta$ VB = 3.7 V $\pm$ 0.15 V<br>ILDO = -5 mA<br>fvin = 100 Hz to 10 kHz  | _     | - 10     | - 5   | dB   | *2    |
|    | Short-circuit current            | ISTLDOPS     | VB = 3.7 V<br>VLDO = 0 V   | 5     | 20       | 40    | mA   | *2    |

Notes) \*2 :Checked by design, not production tested.



REFERENCE VALUES FOR DESIGN

 $V_{VBAT}(DDVBAT1 = VB = VIN2) = 3.1V \ to \ 4.5V, \ DVDD = 1.85V \ , \ DC-DC : Co = 4.7 \ \mu F, \ Lo = 1 \ \mu H \ / \ LDO : Co = 1.0 \ \mu F \ T_a = 25 \ ^{\circ}C \pm 2 \ ^{\circ}C \ unless \ otherwise \ noted.$ 

|    | Parameter                     | Cumbal    | Conditions  | Refe       | erence va | alues | Unit | Notes |
|----|-------------------------------|-----------|---|------------|-----------|-------|------|-------|
|    | Parameter                     | Symbol    | Conditions  | Min        | Тур       | Max   | Unit | Notes |
| DC | DC1 (DC-DC Step Down Regulate | or)       |   |            |           |       |      |       |
|    | Output Voltage                | VDCDC1    | IDCDC1 = - 300 mA<br>Vout = 1.2 V setting                 | 1.170      | 1.200     | 1.230 | V    | *2    |
|    | Consumption current on active | IREGDCCD1 | IDCDC1 = 0 mA   | 10         | 25        | 40    | μΑ   | *2    |
|    | Output over current limit     | ILIMDCDC1 | From FB1 $\times$ 100% to FB1 $\times$ 70% VB = 3.7 V     | _          | 1.0       | 1.2   | А    | *2    |
|    | Efficiency 1                  | EFFDCDC11 | DDVBAT1 = 3.4 V<br>VDCDC1 = 2.4 V<br>IDCDC1 = - 150 mA    | 85         | 90        | _     | %    | *2    |
|    | Efficiency 2                  | EFFDCDC12 | DDVBAT1 = 3.7 V<br>VDCDC1 = 1.2 V<br>IDCDC1 = - 150 mA    | 75         | 80        | _     | %    | *2    |
|    | LX leak current               | ILXL1     | DDVBAT1 = 5.5 V<br>DCDC1 = Disable<br>VLX1 = 0 V or 5.5 V | <b>–</b> 1 | 0         | 1     | μΑ   | *2    |
|    | Discharge resistance          | RDISDCDC1 | _   | 0.5        | 1.0       | 2.0   | kΩ   | *2    |

Notes) \*2 :Checked by design, not production tested.



REFERENCE VALUES FOR DESIGN

 $V_{VBAT}(DDVBAT1 = VB = VIN2) = 3.1V \ to \ 4.5V, \ DVDD = 1.85V \ , \ DC-DC : Co = 4.7 \ \mu F, \ Lo = 1 \ \mu H \ / \ LDO : Co = 1.0 \ \mu F \ T_a = 25 \ ^{\circ}C \pm 2 \ ^{\circ}C \ unless \ otherwise \ noted.$ 

|                  | Doromotor  | Cumbal              | Conditions  | Refe   | rence va | alues | Unit  | Notes |
|------------------|--|---------------------|---|--|----------|-------|-------|-------|
|                  | Parameter  | Symbol              | Conditions  | Min  | Тур      | Max   | Uniii | Notes |
| I <sup>2</sup> C | bus (Internal I/O stage characteristics                            | s)                  |   |  |          |       |       |       |
|                  | Hysteresis of Schmitt trigger input 1                              | Vhys1               | V <sub>IO</sub> > 2 V,<br>Hysteresis 1 of SDA, SCL  | $\begin{array}{c} 0.05 \times \\ V_{DVDD} \end{array}$ | _        | _     | V     | *2    |
|                  | Hysteresis of Schmitt trigger input 2                              | Vhys2               | V <sub>IO</sub> < 2 V,<br>Hysteresis 2 of SDA, SCL  | $0.1 \times V_{DVDD}$                                  | _        | _     | V     | *2    |
|                  | Output fall time from V <sub>IHmin</sub> to V <sub>ILmax</sub>     | Tof                 | Bus capacitance : 10 pF to 400 pF $I_P \le 6$ mA ( $V_{OLmax} = 0.6$ V) $I_P$ : Max. sink current | 20 +<br>0.1 × C <sub>b</sub>                           | _        | 250   | ns    | *2    |
|                  | Pulse width of spikes which must be suppressed by the input filter | Tsp                 | _   | 0  | _        | 50    | ns    | *2    |
|                  | Capacitance for each I/O pin                                       | Ci                  | _   | _  | _        | 10    | pF    | *2    |
| I <sup>2</sup> C | bus (Bus line specifications)                                      |                     |   |  |          |       |       |       |
|                  | Hold time (repeated) START condition                               | t <sub>HD:STA</sub> | The first clock pulse is generated after t <sub>HD:STA</sub> .                                    | 0.6  | _        | _     | μs    | *2    |
|                  | Low period of the SCL clock  | $t_{LOW}$           | _   | 1.3  | _        | _     | μs    | *2    |
|                  | High period of the SCL clock                                       | t <sub>HIGH</sub>   | _   | 0.6  | _        | _     | μs    | *2    |
|                  | Set-up time for a repeat START condition                           | t <sub>SU:STA</sub> | _   | 0.6  | _        | _     | μѕ    | *2    |
|                  | Data hold time   | t <sub>HD:DAT</sub> | _   | 0  | _        | 0.9   | μs    | *2    |
|                  | Data set-up time   | t <sub>SU:DAT</sub> | _   | 100  |          | _     | ns    | *2    |
|                  | Rise time of both SDA and SCL signals                              | t <sub>r</sub>      | _   | 20 +<br>0.1 × C <sub>b</sub>                           | _        | 300   | ns    | *2    |
|                  | Fall time of both SDA and SCL signals                              | t <sub>f</sub>      | _   | 20 +<br>0.1 × C <sub>b</sub>                           | _        | 300   | ns    | *2    |
|                  | Set-up time of STOP condition                                      | t <sub>SU:STO</sub> | _   | 0.6  | _        | _     | μs    | *2    |
|                  | Bus free time between STOP and START condition                     | t <sub>BUF</sub>    | _   | 1.3  | _        | _     | μs    | *2    |

Notes) \*2 :Checked by design, not production tested.



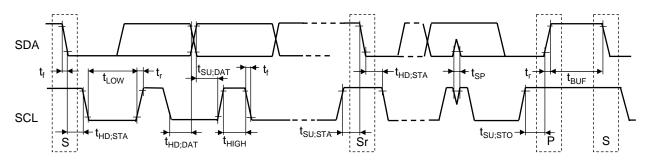
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|                  | Parameter  |                 | Conditions   | Refe                       | rence va | lues | Unit | Notes    |
|------------------|--|-----------------|--|----------------------------|----------|------|------|----------|
|                  |  |                 | Conditions   | Min                        | Тур      | Max  | Unit | Notes    |
| I <sup>2</sup> C | bus (Bus line specifications) (continu                   | ed)             |  |                            |          |      |      |          |
|                  | Capacitive load for each bus line                        |                 | _  | _                          | _        | 400  | pF   | *2<br>*3 |
|                  | Noise margin at the Low-level for each connected device  | V <sub>nL</sub> | _  | 0.1 ×<br>V <sub>DVDD</sub> | _        | _    | ٧    | *2<br>*3 |
|                  | Noise margin at the High-level for each connected device |                 | _  | 0.2 ×<br>V <sub>DVDD</sub> | _        | _    | V    | *2<br>*3 |
| Co               | nsumption current  |                 |  |                            |          |      |      |          |
|                  | Static consumption current 2                             | IBAT_4          | DDVBAT1 = VB = VIN2<br>= 3.7 V<br>DCDC1, LDO1 to 4 = OFF<br>RESET= "H" | _                          | 8        | 17   | μА   | *2       |

Notes) \*2 :Checked by design, not production tested.

\*3 :The timing of Fast-mode devices in I<sup>2</sup>C-bus is specified as the following. All values referred to  $V_{\rm IHmin}$  and  $V_{\rm ILmax}$  level.



S: START condition

Sr: Repeat START condition

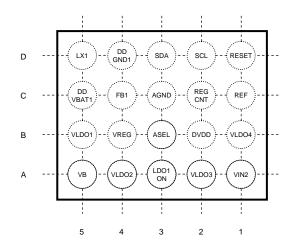
P: STOP condition

Notes) \*2 :Checked by design, not production tested.



# **PIN CONFIGURATION**





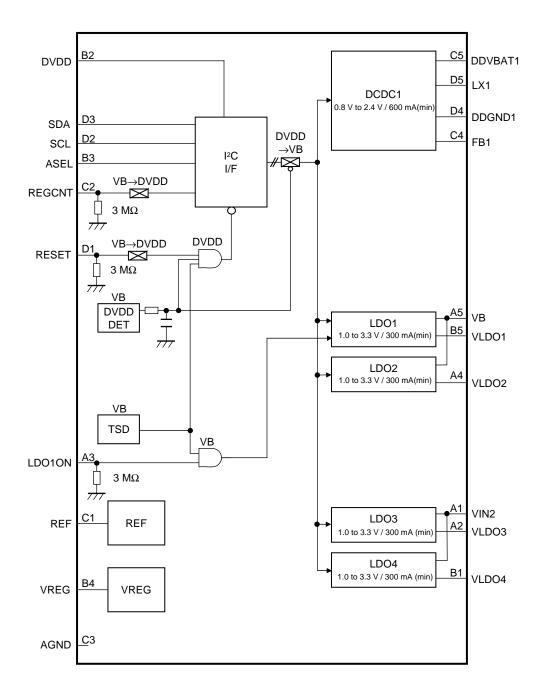
# **PIN FUNCTIONS**

| Pin No. | Pin name | Туре         | Description                           |
|---------|----------|--------------|---------------------------------------|
| A1      | VIN2     | Power Supply | Input for LDO3 and LDO4               |
| A2      | VLDO3    | Output       | LDO3 output                           |
| А3      | LDO10N   | Input        | LDO1 ON/OFF control                   |
| A4      | VLDO2    | Output       | LDO2 output                           |
| A5      | VB       | Power Supply | Input for LDO1, LDO2 and other VB     |
| B1      | VLDO4    | Output       | LDO4 output                           |
| B2      | DVDD     | Power Supply | Power supply for Logic                |
| В3      | ASEL     | Input        | I <sup>2</sup> C slave address select |
| B4      | VREG     | Output       | Reference output                      |
| B5      | VLDO1    | Output       | LDO1 output                           |
| C1      | REF      | Output       | Reference output                      |
| C2      | REGCNT   | Input        | Control to select power setting       |
| C3      | AGND     | Ground       | GND                                   |
| C4      | FB1      | Input        | DCDC1 voltage feedback                |
| C5      | DDVBAT1  | Power Supply | DCDC1 input                           |
| D1      | RESET    | Input        | Reset input for Logic                 |
| D2      | SCL      | Input        | I <sup>2</sup> C clock input          |
| D3      | SDA      | Input/Output | I <sup>2</sup> C data input/output    |
| D4      | DDGND1   | Ground       | GND                                   |
| D5      | LX1      | Output       | DCDC1 switching                       |

Notes) Concerning detail about pin description, please refer to OPERATION and APPLICATION INFORMATION section.



#### **FUNCTIONAL BLOCK DIAGRAM**



Notes) • This application circuit is an example. The operation of mass production set is not guaranteed. You should perform enough evaluation and verification on the design of mass production set. You are fully responsible for the incorporation of the above application circuit and information in the design of your equipment.

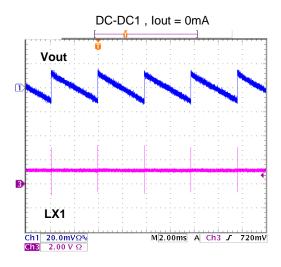
<sup>•</sup> This block diagram is for explaining functions. Part of the block diagram may be omitted, or it may be simplified.

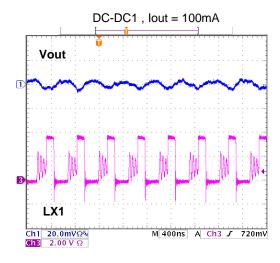


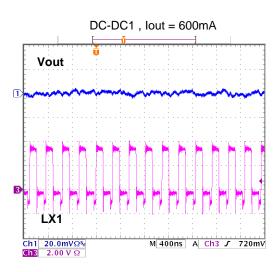
# **TYPICAL CHARACTERISTICS CURVES**

# (1) Output Ripple Voltage of DC-DC1

 $V_{\text{IN}} = 3.7 \text{ V, DC-DC1\_Vout} = 1.2 \text{ V , L1} = 1 \text{ } \mu\text{H} \text{ , CDCDCOUT1} = 4.7 \text{ } \mu\text{F}$ 



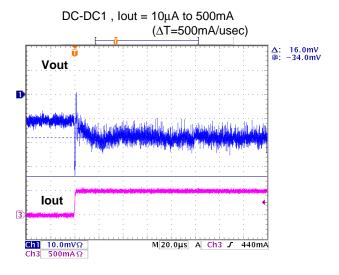


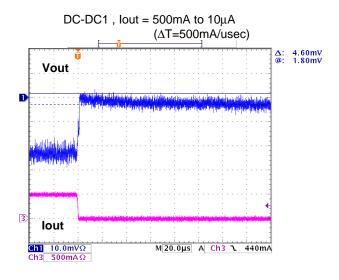




# (2) Load Transient of DC-DC1

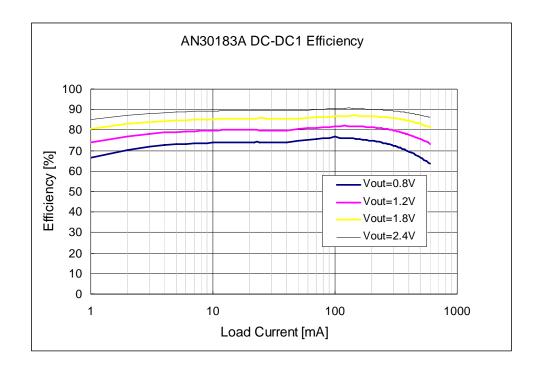
 $\dot{V}_{\text{IN}}$  = 3.7 V, DC-DC1\_Vout = 1.2 V , L1 = 1  $\mu\text{H}$  , CDCDCOUT1 = 4.7  $\mu\text{F}$ 





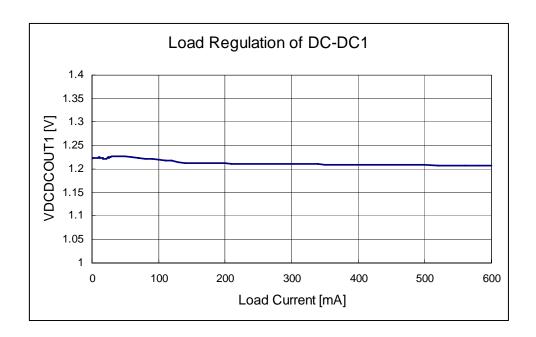


(3) Efficiency of DC-DC1  $$V_{IN}=3.7\ V,\ DC-DC1\_Vout=1.2\ V$  , L1 = 1  $\mu H$  , CDCDCOUT1  $\,=4.7\ \mu F$ 



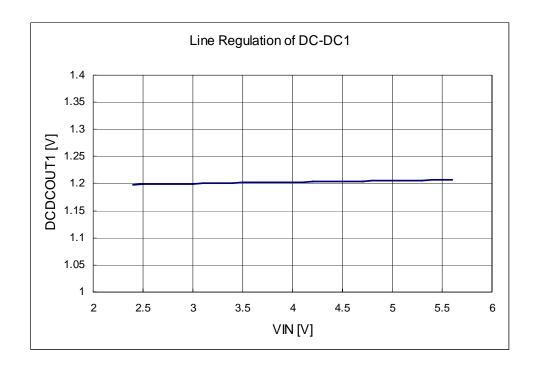


(4) Load Regulation of DC-DC1  $V_{IN}=3.7$  V, DC-DC1\_Vout = 1.2 V , L1 = 1  $\mu H$  , CDCDCOUT1 = 4.7  $\mu F$ 





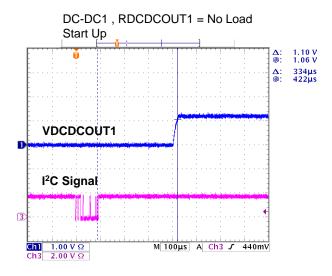
(5) Line Regulation of DC-DC1 lout = 300mA, DC-DC1\_Vout = 1.2 V, L1 = 1  $\mu H$  , CDCDCOUT1  $\,=4.7~\mu F$  ,  $V_{IN}$  = 2.4V to 5.5V

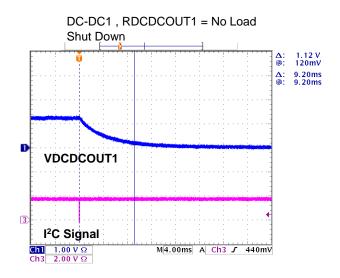




# (6) Start Up & Shut Down of DC-DC1

 $\dot{V}_{\text{IN}}$  = 3.7  $\dot{V}$ , DC-DC1\_Vout = 1.2 V, L1 = 1  $\mu\text{H}$  , CDCDCOUT1 = 4.7  $\mu\text{F}$ 



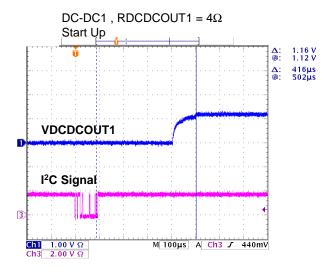


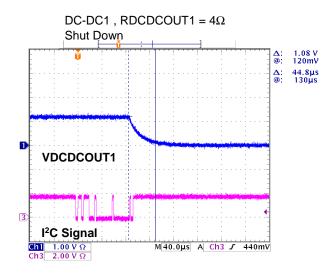
19



# (7) Start Up & Shut Down of DC-DC1 (Continued)

 $\dot{V}_{IN}$  = 3.7  $\dot{V}$ , DC-DC1\_Vout = 1.2 V, L1 = 1  $\mu$ H , CDCDCOUT1 = 4.7  $\mu$ F

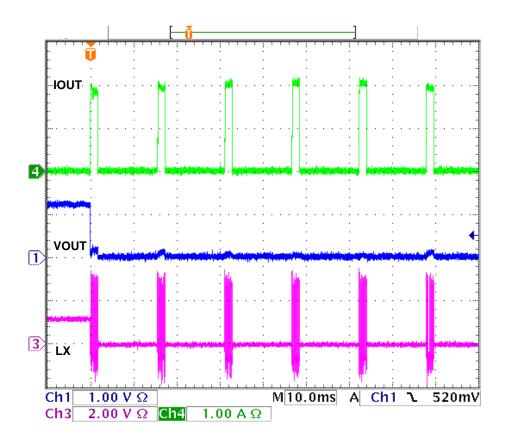






# (8) Short Protection of DC-DC1

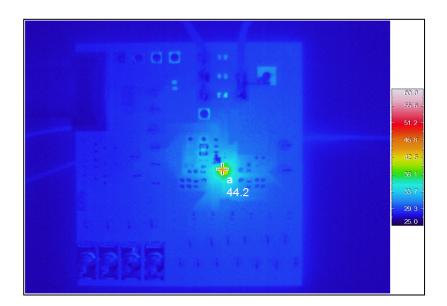
 $V_{\text{IN}}$  = 3.7 V, DC-DC1\_Vout = 1.2 V, L1 = 1  $\mu\text{H}$  , CDCDCOUT1 = 4.7  $\mu\text{F}$ 





# (9) Thermal Performance of DC-DC1

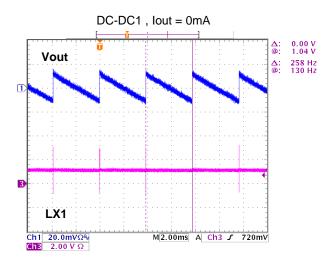
 $V_{\text{IN}}$  = 3.7 V, DC-DC1\_Vout = 1.2 V, ILoad = 600mA , L1 = 1  $\mu\text{H}$  , CDCDCOUT1 = 4.7  $\mu\text{F}$ 

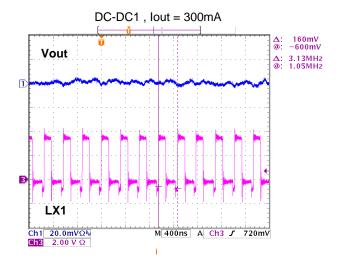


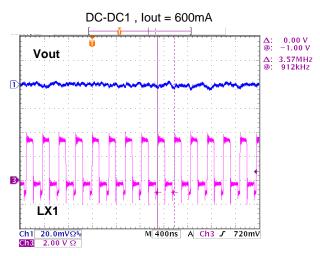


# (10) Frequency of DC-DC1

 $V_{\text{IN}}$  = 3.7 V, DC-DC1\_Vout = 1.2 V, L1 = 1  $\mu\text{H}$  , CDCDCOUT1 = 4.7  $\mu\text{F}$ 

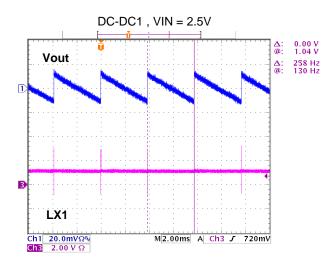


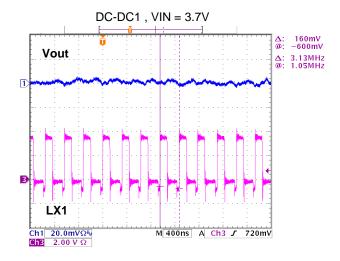


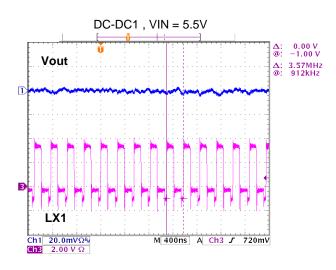




(11) Frequency of DC-DC1 (Continued) IOUT = 300mA, DC-DC1\_Vout = 1.2 V, L1 = 1  $\mu H$  , CDCDCOUT1 = 4.7  $\mu F$ 









#### **OPERATION**

Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

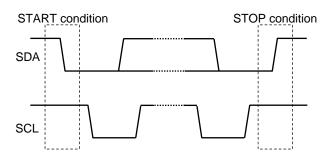
#### 1. I<sup>2</sup>C-bus Interface

#### a.) Basic Rules

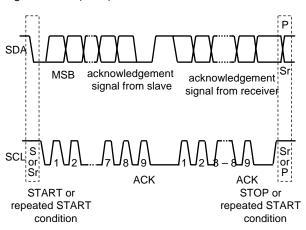
This IC, I2C-bus, is designed to correspond to the Standard-mode (100 kbps) and Fast-mode(400 kbps) devices in the version 2.1 of NXP's specification. However, it does not correspond to the HS-mode (to 3.4 Mbps). This IC will operate as a slave device in the I²C-bus system. This IC will not operate as a master device. The program operation check of this IC has not been conducted on the multi-master bus system and the mix-speed bus system, yet. The connected confirmation of this IC to the CBUS receiver also has not been checked. Please confirm with our company if the IC will be used in these mode systems. The I²C is the brand of NXP.

#### b.) START and STOP conditions

A High to Low transition on the SDA line while SCL is High is one such unique case. This situation indicates START condition. A Low to High transition on the SDA line while SCL is High defines STOP condition. START and STOP conditions are always generated by the master. After START condition occur, the bus will be busy. The bus is considered to be free again a certain time after the STOP condition.



Every byte put on the SDA line must be 8-bits long. The number of bytes that can be transmitted per transfer is unrestricted. Each byte has to be followed by an acknowledge bit. Data is transferred with the most significant bit (MSB) first.

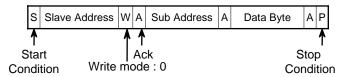


#### d.) Data format

#### Slave Address

| г | D: 40E:  |    |    |    |    |    |    |    | - a |     |
|---|----------|----|----|----|----|----|----|----|-----|-----|
| ı | Pin ASEL | A6 | A5 | A4 | A3 | A2 | A1 | A0 | R/W | Hex |
| Γ | Low      | 1  | 1  | 1  | 0  | 0  | 1  | 0  | х   | 6Eh |
| Γ | High     | 1  | 1  | 1  | 0  | 0  | 1  | 1  | х   | 6Fh |

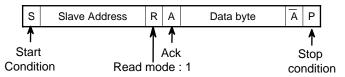
#### Write mode



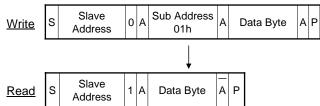
#### Read mode

#### d1.) When Sub address is not specified

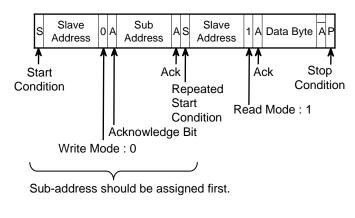
When data is read without assigning sub-address, it is possible to read the value of sub-address specified in Write mode immediately before.



Ex) When writing data into address and reading data from "01 h".



#### d2.) When Sub address is specified





Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

# 2. Register map

| Sub     | R/W      | Register | Dit     |          |       |       | Da    | ata       |       |       |               |
|---------|----------|----------|---------|----------|-------|-------|-------|-----------|-------|-------|---------------|
| Address | K/VV     | Name     | Bit     | D7       | D6    | D5    | D4    | D3        | D2    | D1    | D0            |
| 00h     | R/W      | CNT      | Name    | _        | _     | LD4ON | LD3ON | LD2ON     | LD10N | _     | DD10N         |
| 00h     | K/VV     | CIVI     | Default | 0        | 0     | 0     | 0     | 0         | 0     | 0     | 0             |
| 045     | DAM      | DAC4     | Name    |          | _     | _     |       | VDC1[3:0] |       |       |               |
| 01h     | R/W      | DAC1     | Default | 1        | 1     | 1     | 0     | 1         | 0     | 0     | 0             |
| 0.015   | DAM      | DACO     | Name    |          | VL2   | [3:0] |       | VL1[3:0]  |       |       |               |
| 02h     | R/W      | DAC2     | Default | 0        | 0     | 0     | 0     | 1         | 0     | 0     | 1             |
| 0.215   | DAM DACS | DACO     | Name    | VL4[3:0] |       |       |       |           | VL3   | [3:0] |               |
| 03h     | R/W      | /W DAC3  | Default | 1        | 1     | 0     | 0     | 1         | 0     | 1     | 0             |
| 0.415   | DAM      | CDOUD    | Name    | GPLD4    | GPLD3 | GPLD2 | _     | GPDD      | _     | _     | GPEN          |
| 04h     | R/W      | GROUP    | Default | 1        | 1     | 1     | 1     | 1         | 0     | 0     | 0             |
| 051-    | D///     | DOONIT   | Name    | _        | _     | _     | _     | LD4PS     | LD3PS | LD2PS | LD1PS         |
| 05h     | R/W      | PSCNT    | Default | _        | _     | 0     | 0     | 0         | 0     | 0     | 0             |
| 06h     | R/W      | ENSEL    | Name    | _        | _     | _     | _     | _         | _     | _     | LDO1EN<br>SEL |
|         |          | LIVOLL   | Default |          | _     | _     |       |           | _     | _     | 1             |

| Default Voltage | _ | _ | LDO4 | LDO3 | LDO2 | LDO1  | _ | DCDC1 |
|-----------------|---|---|------|------|------|-------|---|-------|
| Default Voltage | _ | _ | 2.8V | 2.6V | 1.0V | 1.85V | _ | 1.2V  |



Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

#### 3. Register map details

| Sub     | R/W Register | Register | Bit     |    | Data |       |       |       |       |    |       |
|---------|--------------|----------|---------|----|------|-------|-------|-------|-------|----|-------|
| Address | IK/VV        | Name     | DIL     | D7 | D6   | D5    | D4    | D3    | D2    | D1 | D0    |
| 00h     | DAM          | CNT      | Name    | _  | _    | LD4ON | LD3ON | LD2ON | LD10N | _  | DD10N |
| Joon    | R/W          | CIVI     | Default | 0  | 0    | 0     | 0     | 0     | 0     | 0  | 0     |

D5: LDO4 ON/OFF select register

[0]: OFF (default)

[1]: ON

D4: LDO3 ON/OFF select register

[0]: OFF (default)

[1]: ON

D3: LDO2 ON/OFF select register

[0]: OFF (default)

[1]: ON

D2: LDO1 ON/OFF select register

[0]: OFF (default)

[1]: ON

D0 : DCDC1 ON/OFF select register

[0]: OFF (default)

[1]: ON



Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

# 3. Register map details

| Sub     |      | Register | Bit     |    | Data |    |    |    |                  |        |    |  |
|---------|------|----------|---------|----|------|----|----|----|------------------|--------|----|--|
| Address | K/VV | Name     |         | D7 | D6   | D5 | D4 | D3 | D2               | D1     | D0 |  |
| 01h     | DAA  | DA C1    | Name    |    | _    | _  |    |    | VDC <sup>-</sup> | 1[3:0] |    |  |
| OTH     | R/W  | DAC1     | Default | 1  | 1    | 1  | 0  | 1  | 0                | 0      | 0  |  |

D3-0 : DCDC1 Register for output voltage setup

|    | VDC | 1[3:0] |    | Output voltage |
|----|-----|--------|----|----------------|
| D7 | D6  | D5     | D4 | . [V]          |
| 0  | 0   | 0      | 0  | 0.80           |
| 0  | 0   | 0      | 1  | 0.85           |
| 0  | 0   | 1      | 0  | 0.90           |
| 0  | 0   | 1      | 1  | 0.95           |
| 0  | 1   | 0      | 0  | 1.00           |
| 0  | 1   | 0      | 1  | 1.05           |
| 0  | 1   | 1      | 0  | 1.10           |
| 0  | 1   | 1      | 1  | 1.15           |
| 1  | 0   | 0      | 0  | 1.20 (Default) |
| 1  | 0   | 0      | 1  | 1.30           |
| 1  | 0   | 1      | 0  | 1.40           |
| 1  | 0   | 1      | 1  | 1.50           |
| 1  | 1   | 0      | 0  | 1.65           |
| 1  | 1   | 0      | 1  | 1.80           |
| 1  | 1   | 1      | 0  | 1.85           |
| 1  | 1   | 1      | 1  | 2.40           |



Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

# 3. Register map details

| Sub R/W | D/M   | Register<br>Name |         | Dit    | Data |    |     |       |    |    |     |       |  |
|---------|-------|------------------|---------|--------|------|----|-----|-------|----|----|-----|-------|--|
| Address |       |                  | DIL     | D7     | D6   | D5 | D4  | D3    | D2 | D1 | D0  |       |  |
| 02h     | DAV D | R/W              | DACS    | V DAC2 | Name |    | VL2 | [3:0] |    |    | VL1 | [3:0] |  |
| 0211    | FX/VV | DACZ             | Default | 0      | 0    | 0  | 0   | 1     | 0  | 0  | 1   |       |  |

D7-4: LDO2 Register for output voltage setup

|    | VL2 | [3:0] |    | Output voltage |
|----|-----|-------|----|----------------|
| D7 | D6  | D5    | D4 | [V]            |
| 0  | 0   | 0     | 0  | 1.00 (Default) |
| 0  | 0   | 0     | 1  | 1.10           |
| 0  | 0   | 1     | 0  | 1.20           |
| 0  | 0   | 1     | 1  | 1.30           |
| 0  | 1   | 0     | 0  | 1.40           |
| 0  | 1   | 0     | 1  | 1.50           |
| 0  | 1   | 1     | 0  | 1.60           |
| 0  | 1   | 1     | 1  | 1.70           |
| 1  | 0   | 0     | 0  | 1.80           |
| 1  | 0   | 0     | 1  | 1.85           |
| 1  | 0   | 1     | 0  | 2.60           |
| 1  | 0   | 1     | 1  | 2.70           |
| 1  | 1   | 0     | 0  | 2.80           |
| 1  | 1   | 0     | 1  | 2.85           |
| 1  | 1   | 1     | 0  | 3.00           |
| 1  | 1   | 1     | 1  | 3.30           |

D3-0 : LDO1 Register for output voltage setup

|    | VL1 | [3:0] |    | Output voltage |
|----|-----|-------|----|----------------|
| D3 | D2  | D1    | D0 | [V]            |
| 0  | 0   | 0     | 0  | 1.00           |
| 0  | 0   | 0     | 1  | 1.10           |
| 0  | 0   | 1     | 0  | 1.20           |
| 0  | 0   | 1     | 1  | 1.30           |
| 0  | 1   | 0     | 0  | 1.40           |
| 0  | 1   | 0     | 1  | 1.50           |
| 0  | 1   | 1     | 0  | 1.60           |
| 0  | 1   | 1     | 1  | 1.70           |
| 1  | 0   | 0     | 0  | 1.80           |
| 1  | 0   | 0     | 1  | 1.85 (Default) |
| 1  | 0   | 1     | 0  | 1.90           |
| 1  | 0   | 1     | 1  | 2.70           |
| 1  | 1   | 0     | 0  | 2.80           |
| 1  | 1   | 0     | 1  | 2.85           |
| 1  | 1   | 1     | 0  | 3.00           |
| 1  | 1   | 1     | 1  | 3.30           |



Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

# 3. Register map details

| Sub<br>Address R/W | Register | Bit  |         | Data |    |     |       |    |    |     |       |  |
|--------------------|----------|------|---------|------|----|-----|-------|----|----|-----|-------|--|
|                    | Name     |      | D7      | D6   | D5 | D4  | D3    | D2 | D1 | D0  |       |  |
| 03h                | R/W [    | DACS | DAC3    | Name |    | VL4 | [3:0] |    |    | VL3 | [3:0] |  |
| USII               | K/VV     | DACS | Default | 1    | 1  | 0   | 0     | 1  | 0  | 1   | 0     |  |

D7-4: LDO4 Register for output voltage setup

|    | VL4 | [3:0] |    | Output voltage |
|----|-----|-------|----|----------------|
| D7 | D6  | D5    | D4 | . [V]          |
| 0  | 0   | 0     | 0  | 1.00           |
| 0  | 0   | 0     | 1  | 1.10           |
| 0  | 0   | 1     | 0  | 1.20           |
| 0  | 0   | 1     | 1  | 1.30           |
| 0  | 1   | 0     | 0  | 1.40           |
| 0  | 1   | 0     | 1  | 1.50           |
| 0  | 1   | 1     | 0  | 1.60           |
| 0  | 1   | 1     | 1  | 1.70           |
| 1  | 0   | 0     | 0  | 1.80           |
| 1  | 0   | 0     | 1  | 1.85           |
| 1  | 0   | 1     | 0  | 2.60           |
| 1  | 0   | 1     | 1  | 2.70           |
| 1  | 1   | 0     | 0  | 2.80 (Default) |
| 1  | 1   | 0     | 1  | 2.85           |
| 1  | 1   | 1     | 0  | 3.00           |
| 1  | 1   | 1     | 1  | 3.30           |

D3-0 : LDO3 Register for output voltage setup

|    | VL3 | [3:0] |    | Output voltage |
|----|-----|-------|----|----------------|
| D3 | D2  | D1    | D0 | [V]            |
| 0  | 0   | 0     | 0  | 1.00           |
| 0  | 0   | 0     | 1  | 1.10           |
| 0  | 0   | 1     | 0  | 1.20           |
| 0  | 0   | 1     | 1  | 1.30           |
| 0  | 1   | 0     | 0  | 1.40           |
| 0  | 1   | 0     | 1  | 1.50           |
| 0  | 1   | 1     | 0  | 1.60           |
| 0  | 1   | 1     | 1  | 1.70           |
| 1  | 0   | 0     | 0  | 1.80           |
| 1  | 0   | 0     | 1  | 1.85           |
| 1  | 0   | 1     | 0  | 2.60 (Default) |
| 1  | 0   | 1     | 1  | 2.70           |
| 1  | 1   | 0     | 0  | 2.80           |
| 1  | 1   | 0     | 1  | 2.85           |
| 1  | 1   | 1     | 0  | 3.00           |
| 1  | 1   | 1     | 1  | 3.30           |



Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

#### 3. Register map details

| Sub<br>Address | R/W | Register<br>Name | Bit     | Data  |       |       |    |      |    |    |      |  |
|----------------|-----|------------------|---------|-------|-------|-------|----|------|----|----|------|--|
|                |     |                  |         | D7    | D6    | D5    | D4 | D3   | D2 | D1 | D0   |  |
| 04h            | R/W | GROUP            | Name    | GPLD4 | GPLD3 | GPLD2 | _  | GPDD | _  | _  | GPEN |  |
|                |     |                  | Default | 1     | 1     | 1     | 1  | 1    | 0  | 0  | 0    |  |

<sup>\*</sup> Please set it to normal mode when LDO starts.

D7: External pin ON/OFF control for LDO4 select register

[0]: I2C control

[1]: External pin control (default)

D6: External pin ON/OFF control for LDO3 select register

[0]: I2C control

[1]: External pin control (default)

D5: External pin ON/OFF control for LDO2 select register

[0]: I2C control

[1]: External pin control (default)

D3: External pin ON/OFF control for DCDC1 select register

[0]: I2C control

[1]: External pin control (default)

D0 : External pin control permit register

[0]: External pin control valid (default)

[1]: External pin control invalid



Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

#### 3. Register map details

<REGCNT pin control - set up method>

- (1) REGCNT Pin Control setup (excluding LDO1)
  - Initial setup
  - Select the LDO/DCDC to be controlled by REGCNT (Address:04h Single Bit from D7-5, D3 should be set to "H") Set D0 to "H"
  - Set the LDO/DCDC Startup register mentioned above in ① to "H" (To control LDO1 set Address:00h D2:LDO1ON to "H")
     Set the LDO to be controlled to Normal Mode (Address:05h Default)
  - Startup Control
  - 3) LDO/DCDC selected in 1) above will startup when REGCNT is set to "H" Power Save Mode for the LDO can be controlled by the I<sup>2</sup>C When the Startup register mentioned in 2) above (Address:00h) is set to "L", the LDO/DCDC will turn off.
  - 4) The Startup for LDO/DCDC not selected in 1) can also be controlled by the I<sup>2</sup>C
  - 5) To turn off the LDO mentioned in 1) above, set the REGCNT to "L".

    When the LDO is turned OFF in the Power Save Mode, reset Address:05h to Normal Mode before turning on the LDO using the REGCNT pin.
  - Example Using the REGCNT pin to control LDO2 and LDO3
  - 1) ADDRESS 04h : DATA 61h
  - 2) ADDRESS 00h: DATA 18h
  - 3) Set REGCNT pin "L" to "H": LDO2,3 Startup
  - 4) Use I<sup>2</sup>C to control the Output Voltage and Power Save Mode settings
  - 5) To stop LDO2 and LDO3, Set REGCNT from "H" to "L"
- (2) Control using the I2C only
  - Initial Setup
     No special settings required after RESET
     (ADDRESS 04h Bit D0 set to "L)
  - (Startup control)

The REGCNT pin should be set to "L" when using the  $I^2C$  for LDO/DCDC Startup/Shutdown, Power Save Mode and Output Voltage Setup.



Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

#### 3. Register map details

| Sub<br>Address | R/W | Register<br>Name | Bit     | Data |    |    |    |       |       |       |       |  |
|----------------|-----|------------------|---------|------|----|----|----|-------|-------|-------|-------|--|
|                |     |                  |         | D7   | D6 | D5 | D4 | D3    | D2    | D1    | D0    |  |
| 05h            | R/W | PSCNT            | Name    | _    | _  | _  | _  | LD4PS | LD3PS | LD2PS | LD1PS |  |
|                |     |                  | Default |      | -  | 0  | 0  | 0     | 0     | 0     | 0     |  |

\*Please set it to normal mode when LDO starts.

D3: LDO4 Power save mode select register

[0]: Normal mode (default)[1]: Power save mode

D2: LDO3 Power save mode select register

[0]: Normal mode (default)[1]: Power save mode

D1: LDO2 Power save mode select register

[0]: Normal mode (default)[1]: Power save mode

D0: LDO1 Power save mode select register

[0]: Normal mode (default)[1]: Power save mode



Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

# 3. Register map details

| Sub<br>Address | R/W | Register<br>Name | Bit     | Data |    |    |    |    |    |    |               |  |
|----------------|-----|------------------|---------|------|----|----|----|----|----|----|---------------|--|
|                |     |                  |         | D7   | D6 | D5 | D4 | D3 | D2 | D1 | D0            |  |
| 06h            | R/W | ENSEL            | Name    | _    | _  | _  | _  | _  | _  | _  | LDO1EN<br>SEL |  |
|                |     |                  | Default | _    | _  | _  | _  | _  | _  | _  | 1             |  |

D0: LDO1ENSEL

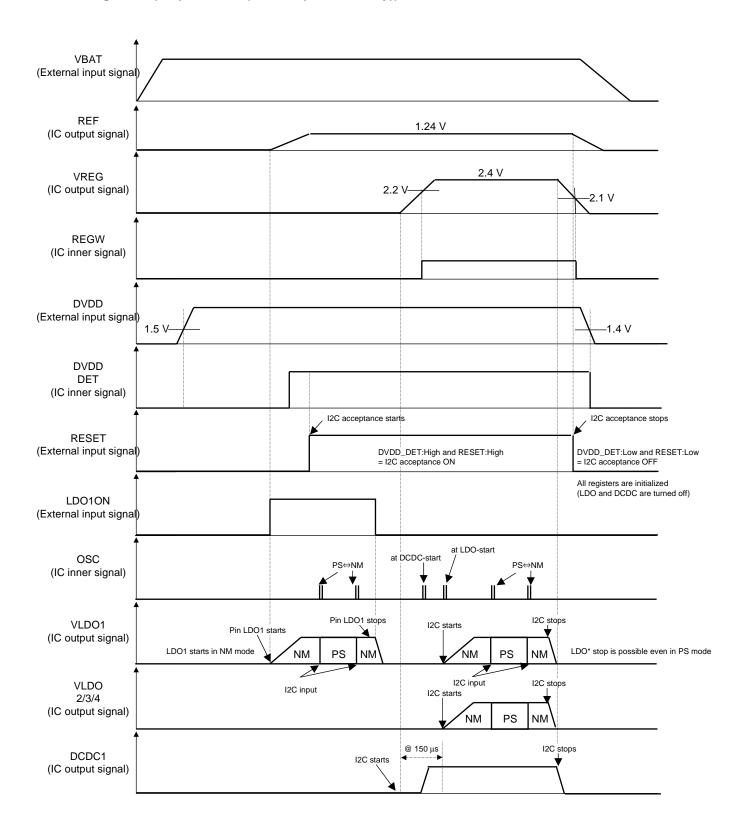
[0]: LDO1ON control invalid

[1]: LDO1ON control valid (default)



Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

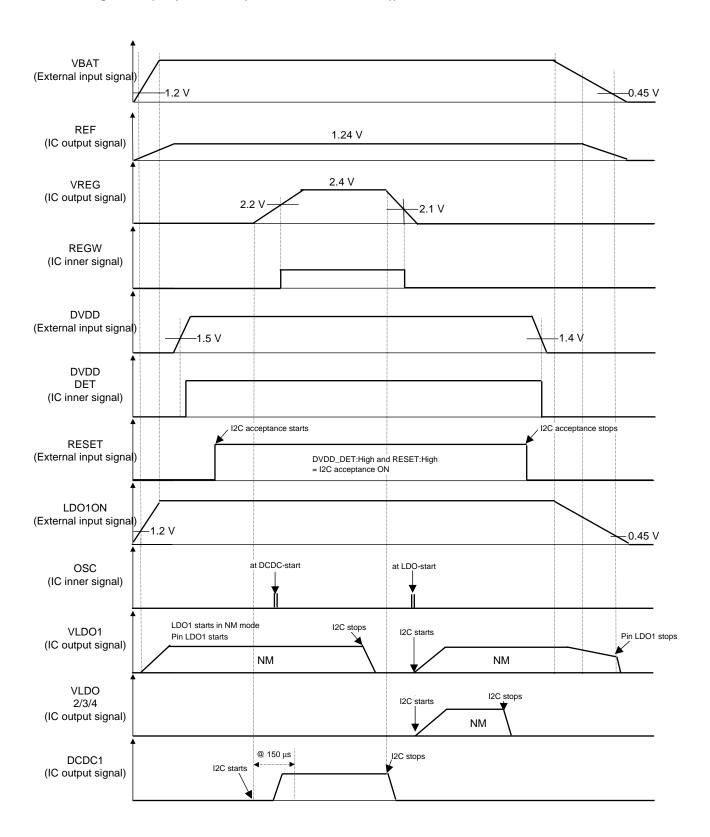
# 4. Timing Chart (Sequence - 1 (DVDD input externally))





Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

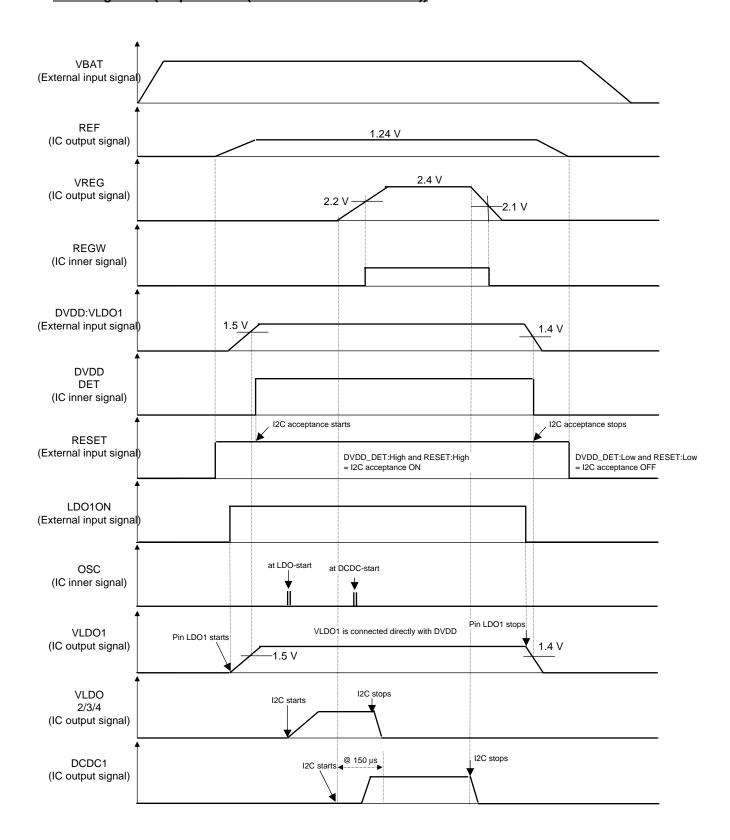
# 4. Timing Chart (Sequence - 2 (LDO10N = fixed VBAT))





Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

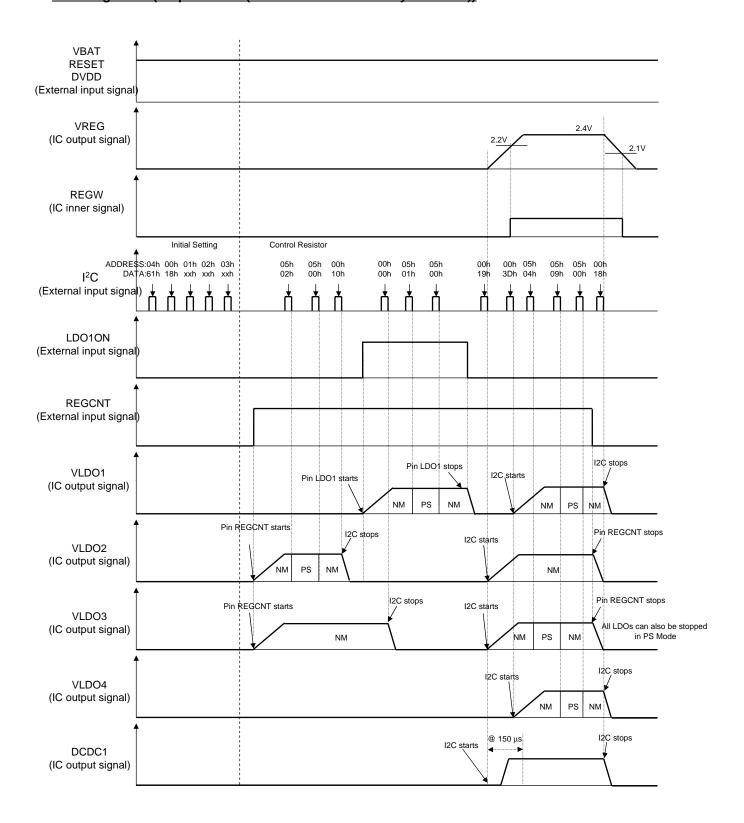
# 4. Timing Chart (Sequence - 3 (VLDO1 = connected DVDD))





Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

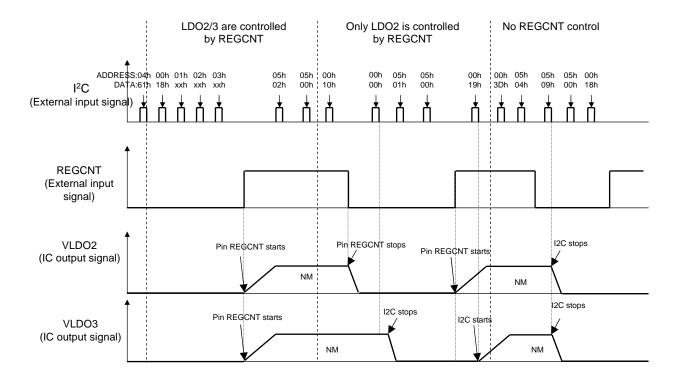
#### 4. Timing Chart (Sequence - 4 (LDO2/3 are controlled by REGCNT))





Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

# 4. Timing Chart (Sequence - 4 (LDO2/3 are controlled by REGCNT)) (continued)

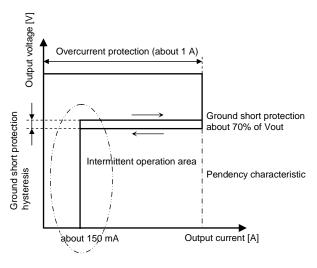




Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

# 5. DC-DC Protection Operation

- < Operation explanation >
  - (1) The Overcurrent protection operates at about 1 A (Typ).
  - (2) The Ground protection sequence is implemented when the output voltage decreases to about 70% of the set voltage.
  - (3) The Ground short protection operates intermittently. (2 ms : ON, 16 ms : OFF)



Operation explanation chart

# 6. DAC voltage Accuracy

DCDC1 (VBAT = 3.7 V, lout = -300 mA)

|    | VDC | 1[3:0] | Output voltage | Accuracy       |      |  |
|----|-----|--------|----------------|----------------|------|--|
| D3 | D2  | D1     | D0             | [V]            | [%]  |  |
| 0  | 0   | 0      | 0              | 0.80           | ±8.5 |  |
| 0  | 0   | 0      | 1              | 0.85           | ±6.5 |  |
| 0  | 0   | 1      | 0              | 0.90           | ±6.5 |  |
| 0  | 0   | 1      | 1              | 0.95           | ±6.0 |  |
| 0  | 1   | 0      | 0              | 1.00           | ±6.0 |  |
| 0  | 1   | 0      | 1              | 1.05           | ±5.0 |  |
| 0  | 1   | 1      | 0              | 1.10           | ±4.0 |  |
| 0  | 1   | 1      | 1              | 1.15           | ±3.5 |  |
| 1  | 0   | 0      | 0              | 1.20 (Default) | ±2.5 |  |
| 1  | 0   | 0      | 1              | 1.30           | ±3.0 |  |
| 1  | 0   | 1      | 0              | 1.40           | ±4.0 |  |
| 1  | 0   | 1      | 1              | 1.50           | ±3.0 |  |
| 1  | 1   | 0      | 0              | 1.65           | ±3.0 |  |
| 1  | 1   | 0      | 1              | 1.80           | ±4.0 |  |
| 1  | 1   | 1      | 0              | 1.85           | ±3.0 |  |
| 1  | 1   | 1      | 1              | 2.40           | ±3.0 |  |



Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

# 6. DAC Voltage Accuracy (continued)

LDO VBAT = 3.7 V (Normal-mode : lout = -150 mA, PS-mode : lout = -5 mA)

| VL1[3:0] |    |     |      | Accuracy [%]       |             |           |         |      |
|----------|----|-----|------|--------------------|-------------|-----------|---------|------|
| Do       | DO | D4  | Do   | Output voltage [V] | Normal-mode |           | PS-mode |      |
| D3 D2 D1 | D0 | [1] | LDO1 | LDO2 to 4          | LDO1        | LDO2 to 4 |         |      |
| 0        | 0  | 0   | 0    | 1.00               | ±5.0        | ±5.0      | ±5.0    | ±5.0 |
| 0        | 0  | 0   | 1    | 1.10               | ±4.5        | ±4.5      | ±4.5    | ±4.5 |
| 0        | 0  | 1   | 0    | 1.20               | ±4.0        | ±4.0      | ±4.0    | ±4.0 |
| 0        | 0  | 1   | 1    | 1.30               | ±4.0        | ±4.0      | ±4.0    | ±4.0 |
| 0        | 1  | 0   | 0    | 1.40               | ±3.0        | ±3.0      | ±3.0    | ±3.0 |
| 0        | 1  | 0   | 1    | 1.50               | ±3.0        | ±3.0      | ±3.0    | ±3.0 |
| 0        | 1  | 1   | 0    | 1.60               | ±3.0        | ±3.0      | ±3.0    | ±3.0 |
| 0        | 1  | 1   | 1    | 1.70               | ±3.0        | ±3.0      | ±3.0    | ±3.0 |
| 1        | 0  | 0   | 0    | 1.80               | ±3.0        | ±3.0      | ±3.0    | ±3.0 |
| 1        | 0  | 0   | 1    | 1.85               | ±2.5        | ±2.5      | ±2.5    | ±2.5 |
|          | 4  | 1   |      | 1.90               | ±2.5        | _         | ±2.5    | _    |
| 1 0      | I  | 0   | 2.60 | _                  | ±3.0        | _         | ±3.0    |      |
| 1        | 0  | 1   | 1    | 2.70               | ±3.0        | ±3.0      | ±3.0    | ±3.0 |
| 1        | 1  | 0   | 0    | 2.80               | ±3.0        | ±3.0      | ±3.0    | ±3.0 |
| 1        | 1  | 0   | 1    | 2.85               | ±3.0        | ±3.0      | ±3.0    | ±3.0 |
| 1        | 1  | 1   | 0    | 3.00               | ±3.0        | ±3.0      | ±3.0    | ±3.0 |
| 1        | 1  | 1   | 1    | 3.30               | ±3.0        | ±3.0      | ±3.0    | ±3.0 |

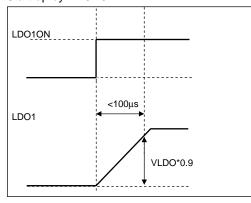


Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

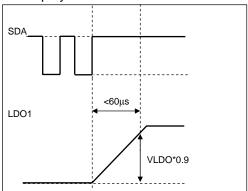
# 7. Start Up Timing from LDO10N, REGCNT and I2C

#### (1) Start up LDO1

# Start up by LDO10N

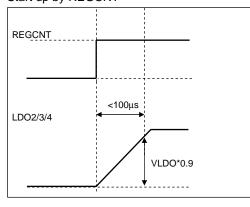


# Start up by I2C

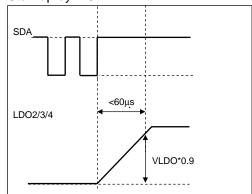


# (2) Start up LDO2/3/4 and DCDC1

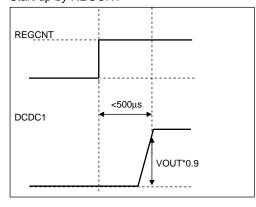
# Start up by REGCNT



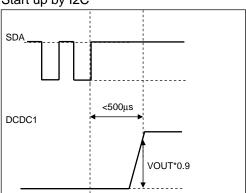
# Start up by I2C



# Start up by REGCNT



#### Start up by I2C





#### APPLICATION INFORMATION

Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

## 1.Application Circuit and Evaluation Board

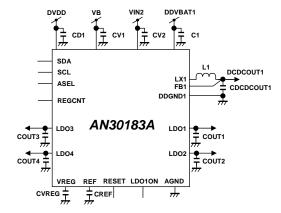


Figure: Application Circuit

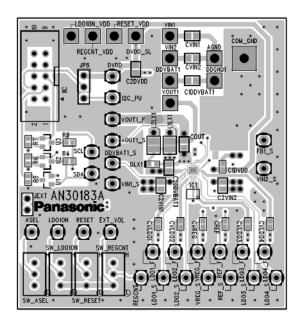


Figure : Top Layer with silk screen ( Top View ) with Evaluation Board

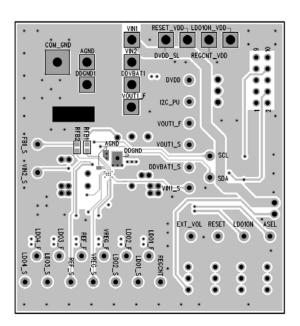


Figure: Bottom Layer with silk screen (Bottom View) with Evaluation Board

Notes) This application circuit and layout is an example. The operation of mass production set is not guaranteed. You should perform enough evaluation and verification on the design of mass production set. You are fully responsible for the incorporation of the above application circuit and information in the design of your equipment.



# **APPLICATION INFORMATION (Continued)**

Note) The characteristics listed below are reference values derived from the design of the IC and are not guaranteed.

# 2.RECOMMENDED COMPONENT

| Reference Designator | QTY | Value  | Manufacturer | Part Number       |
|----------------------|-----|--------|--------------|-------------------|
| C1                   | 1   | 4.7µF  | Murata       | GRM21BB31C475KA87 |
| CV1                  | 1   | 4.7µF  | Murata       | GRM21BB31C475KA87 |
| VC2                  | 1   | 4.7µF  | Murata       | GRM21BB31C475KA87 |
| CD1                  | 1   | 0.1µF  | Murata       | GRM188B11C104KA01 |
| L1                   | 1   | 1.0 µH | FDK          | MIPSZ2012D1R0     |
| CDCDCOUT1            | 1   | 4.7µF  | Murata       | GRM21BB31A475KA74 |
| COUT1                | 1   | 1.0µF  | Murata       | GRM185B31A105KE35 |
| COUT2                | 1   | 1.0µF  | Murata       | GRM185B31A105KE35 |
| COUT3                | 1   | 1.0µF  | Murata       | GRM185B31A105KE35 |
| COUT4                | 1   | 1.0µF  | Murata       | GRM185B31A105KE35 |
| CVREG                | 1   | 1.0µF  | Murata       | GRM185B31A105KE35 |
| CREF                 | 1   | 1.0µF  | Murata       | GRM185B31A105KE35 |

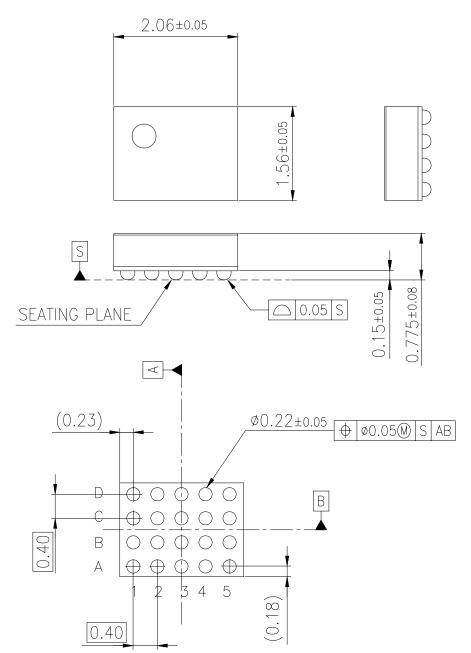
Figure: Recommended Component



# PACKAGE INFORMATION (Reference Data)

Outline Drawing

Package Code : XBGA020-W-1621AEL Unit:mm



Body Materia I : Br/Sb Free Epoxy resin

Reroute Material: Cu

Bump : SnAgCu



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- (4) Submarine transponder
- (5) Control equipment for power plant
- (6) Disaster prevention and security device
- (7) Weapon
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- 2. Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
- 3. Pay attention to the direction of LSI. When mounting it in the wrong direction onto the PCB (printed-circuit-board), it might smoke or ignite.
- 4. Pay attention in the PCB (printed-circuit-board) pattern layout in order to prevent damage due to short circuit between pins. In addition, refer to the Pin Description for the pin configuration.
- 5. Perform a visual inspection on the PCB before applying power, otherwise damage might happen due to problems such as a solder-bridge between the pins of the semiconductor device. Also, perform a full technical verification on the assembly quality, because the same damage possibly can happen due to conductive substances, such as solder ball, that adhere to the LSI during transportation.
- 6. Take notice in the use of this product that it might break or occasionally smoke when an abnormal state occurs such as output pin-VCC short (Power supply fault), output pin-GND short (Ground fault), or output-to-output-pin short (load short).
  - And, safety measures such as an installation of fuses are recommended because the extent of the abovementioned damage and smoke emission will depend on the current capability of the power supply.
- 7. The protection circuit is for maintaining safety against abnormal operation. Therefore, the protection circuit should not work during normal operation.
  - Especially for the thermal protection circuit, if the area of safe operation or the absolute maximum rating is momentarily exceeded due to output pin to VCC short (Power supply fault), or output pin to GND short (Ground fault), the LSI might be damaged before the thermal protection circuit could operate.
- 8. Unless specified in the product specifications, make sure that negative voltage or excessive voltage are not applied to the pins because the device might be damaged, which could happen due to negative voltage or excessive voltage generated during the ON and OFF timing when the inductive load of a motor coil or actuator coils of optical pick-up is being driven.
- 9. The product which has specified ASO (Area of Safe Operation) should be operated in ASO
- 10. Verify the risks which might be caused by the malfunctions of external components.
- 11. Connect the metallic plates on the back side of the LSI with their respective potentials (AGND, PVIN, LX). The thermal resistance and the electrical characteristics are guaranteed only when the metallic plates are connected with their respective potentials.

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  - Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
- (6) Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
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- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001:
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: <u>org@eplast1.ru</u>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина,

дом 2, корпус 4, литера А.